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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

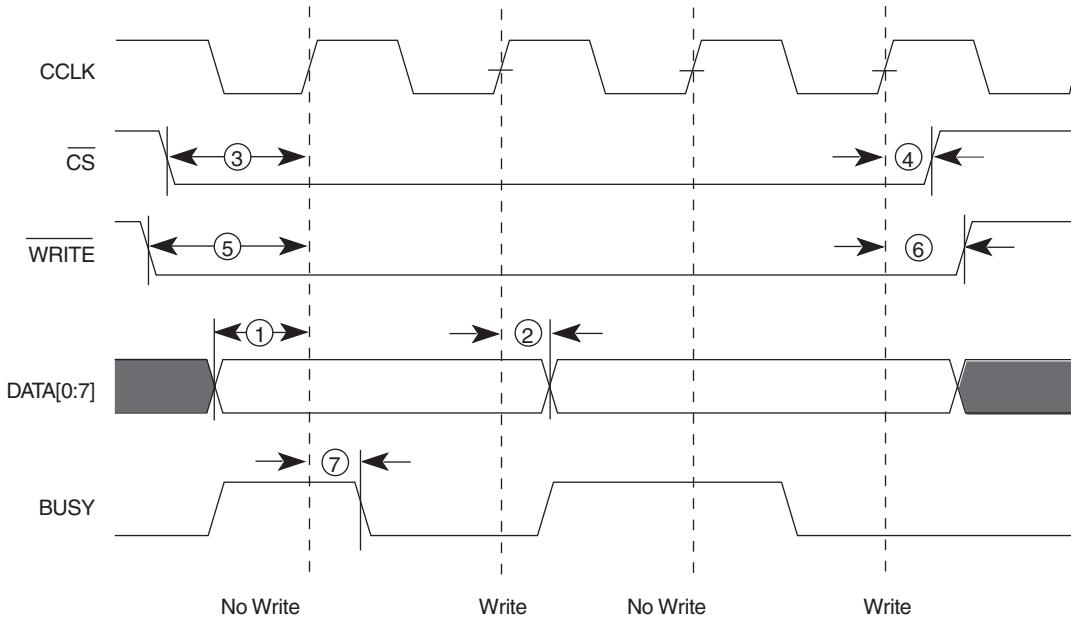
Details

Product Status	Obsolete
Number of LABs/CLBs	6144
Number of Logic Elements/Cells	27648
Total RAM Bits	393216
Number of I/O	512
Number of Gates	1569178
Voltage - Supply	1.71V ~ 1.89V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	680-LBGA Exposed Pad
Supplier Device Package	680-FTEBGA (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xcv1000e-6fg680i

3. At the rising edge of CCLK: If BUSY is Low, the data is accepted on this clock. If BUSY is High (from a previous write), the data is not accepted. Acceptance instead occurs on the first clock after BUSY goes Low, and the data must be held until this has happened.
4. Repeat steps 2 and 3 until all the data has been sent.
5. De-assert \overline{CS} and \overline{WRITE} .

Table 11: SelectMAP Write Timing Characteristics

	Description		Symbol		Units
CCLK	D ₀₋₇ Setup/Hold	1/2	T_{SMDCC}/T_{SMCCD}	5.0 / 1.7	ns, min
	\overline{CS} Setup/Hold	3/4	T_{SMCSCC}/T_{SMCCCS}	7.0 / 1.7	ns, min
	\overline{WRITE} Setup/Hold	5/6	T_{SMCCW}/T_{SMWCC}	7.0 / 1.7	ns, min
	BUSY Propagation Delay	7	T_{SMCKBY}	12.0	ns, max
	Maximum Frequency		f_{CC}	66	MHz, max
	Maximum Frequency with no handshake		f_{CCNH}	50	MHz, max



DS022_45_071702

Figure 17: Write Operations

A flowchart for the write operation is shown in Figure 18. Note that if CCLK is slower than f_{CCNH} , the FPGA never asserts BUSY. In this case, the above handshake is unnecessary, and data can simply be entered into the FPGA every CCLK cycle.

Abort

During a given assertion of \overline{CS} , the user cannot switch from a write to a read, or vice-versa. This action causes the cur-

rent packet command to be aborted. The device remains BUSY until the aborted operation has completed. Following an abort, data is assumed to be unaligned to word boundaries, and the FPGA requires a new synchronization word prior to accepting any new packets.

To initiate an abort during a write operation, de-assert \overline{WRITE} . At the rising edge of CCLK, an abort is initiated, as shown in Figure 19.

Configuration through the TAP uses the CFG_IN instruction. This instruction allows data input on TDI to be converted into data packets for the internal configuration bus.

The following steps are required to configure the FPGA through the Boundary Scan port (when using TCK as a start-up clock).

1. Load the CFG_IN instruction into the Boundary Scan instruction register (IR).
2. Enter the Shift-DR (SDR) state.
3. Shift a configuration bitstream into TDI.
4. Return to Run-Test-Idle (RTI).
5. Load the JSTART instruction into IR.
6. Enter the SDR state.
7. Clock TCK through the startup sequence.
8. Return to RTI.

Configuration and readback via the TAP is always available. The Boundary Scan mode is selected by a $<101>$ or $<001>$ on the mode pins (M2, M1, M0). For details on TAP characteristics, refer to XAPP139.

Configuration Sequence

The configuration of Virtex-E devices is a three-phase process. First, the configuration memory is cleared. Next, configuration data is loaded into the memory, and finally, the logic is activated by a start-up process.

Configuration is automatically initiated on power-up unless it is delayed by the user, as described below. The configuration process can also be initiated by asserting PROGRAM. The end of the memory-clearing phase is signalled by INIT going High, and the completion of the entire process is signalled by DONE going High.

The power-up timing of configuration signals is shown in Figure 20.

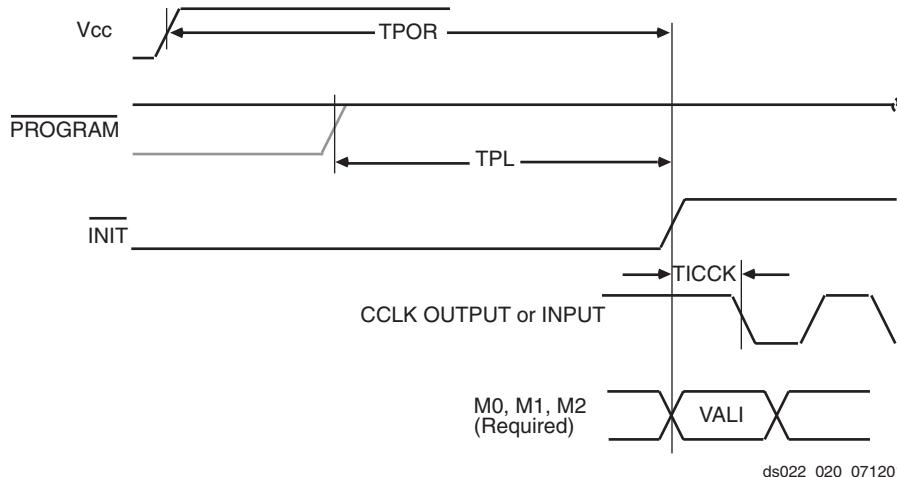


Figure 20: Power-Up Timing Configuration Signals

The corresponding timing characteristics are listed in Table 12.

Table 12: Power-up Timing Characteristics

Description	Symbol	Value	Units
Power-on Reset ¹	T _{POR}	2.0	ms, max
Program Latency	T _{PL}	100.0	μs, max
CCLK (output) Delay	T _{ICCK}	0.5	μs, min
		4.0	μs, max
Program Pulse Width	T _{PROGRAM}	300	ns, min

Notes:

1. T_{POR} delay is the initialization time required after V_{CCINT} and V_{CCO} in Bank 2 reach the recommended operating voltage.

Delaying Configuration

INIT can be held Low using an open-drain driver. An open-drain is required since INIT is a bidirectional open-drain pin that is held Low by the FPGA while the configuration memory is being cleared. Extending the time that the pin is Low causes the configuration sequencer to wait. Thus, configuration is delayed by preventing entry into the phase where data is loaded.

Start-Up Sequence

The default Start-up sequence is that one CCLK cycle after DONE goes High, the global 3-state signal (GTS) is released. This permits device outputs to turn on as necessary.

One CCLK cycle later, the Global Set/Reset (GSR) and Global Write Enable (GWE) signals are released. This permits

Because any single DLL can access only two BUFGs at most, any additional output clock signals must be routed from the DLL in this example on the high speed backbone routing.

The dll_2x files in the [xapp132.zip](#) file show the VHDL and Verilog implementation of this circuit.

Virtex-E 4x Clock

Two DLLs located in the same half-edge (top-left, top-right, bottom-right, bottom-left) can be connected together, without using a BUFG between the CLKDLLs, to generate a 4x clock as shown in [Figure 30](#). Virtex-E devices, like the Virtex devices, have four clock networks that are available for internal deskewing of the clock. Each of the eight DLLs have access to two of the four clock networks. Although all the DLLs can be used for internal deskewing, the presence of two GCLKBufs on the top and two on the bottom indicate that only two of the four DLLs on the top (and two of the four DLLs on the bottom) can be used for this purpose.

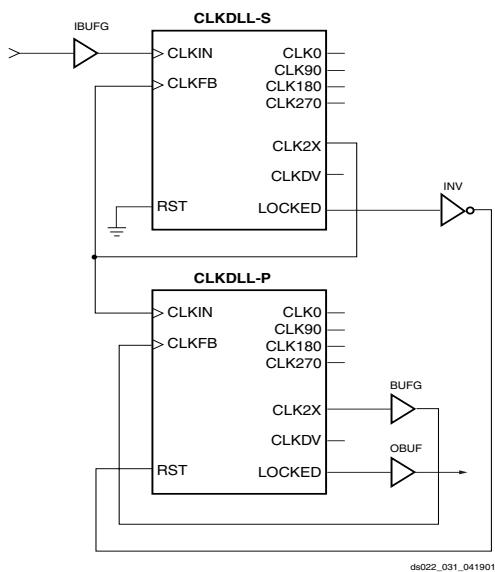


Figure 30: DLL Generation of 4x Clock in Virtex-E Devices

The dll_4xe files in the xapp132.zip file show the DLL implementation in Verilog for Virtex-E devices. These files can be found at:

<http://ftp.xilinx.com/pub/applications/xapp/xapp132.zip>

Using Block SelectRAM+ Features

The Virtex FPGA Series provides dedicated blocks of on-chip, true dual-read/write port synchronous RAM, with 4096 memory cells. Each port of the block SelectRAM+ memory can be independently configured as a read/write port, a read port, a write port, and can be configured to a specific data width. The block SelectRAM+ memory offers

new capabilities allowing the FPGA designer to simplify designs.

Operating Modes

Virtex-E block SelectRAM+ memory supports two operating modes:

- Read Through
- Write Back

Read Through (one clock edge)

The read address is registered on the read port clock edge and data appears on the output after the RAM access time. Some memories might place the latch/register at the outputs, depending on whether a faster clock-to-out versus set-up time is desired. This is generally considered to be an inferior solution, since it changes the read operation to an asynchronous function with the possibility of missing an address/control line transition during the generation of the read pulse clock.

Write Back (one clock edge)

The write address is registered on the write port clock edge and the data input is written to the memory and mirrored on the output.

Block SelectRAM+ Characteristics

- All inputs are registered with the port clock and have a set-up to clock timing specification.
- All outputs have a read through or write back function depending on the state of the port WE pin. The outputs relative to the port clock are available after the clock-to-out timing specification.
- The block SelectRAMs are true SRAM memories and do not have a combinatorial path from the address to the output. The LUT SelectRAM+ cells in the CLBs are still available with this function.
- The ports are completely independent from each other (*i.e.*, clocking, control, address, read/write function, and data width) without arbitration.
- A write operation requires only one clock edge.
- A read operation requires only one clock edge.

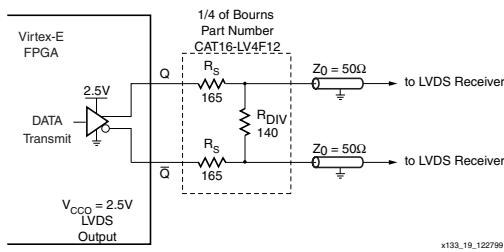
The output ports are latched with a self timed circuit to guarantee a glitch free read. The state of the output port does not change until the port executes another read or write operation.

Library Primitives

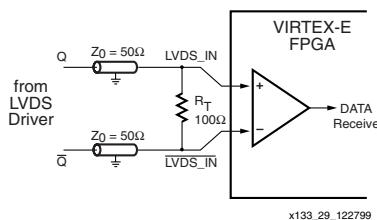
[Figure 31](#) and [Figure 32](#) show the two generic library block SelectRAM+ primitives. [Table 14](#) describes all of the available primitives for synthesis and simulation.

LVDS

Depending on whether the device is transmitting an LVDS signal or receiving an LVDS signal, there are two different circuits used for LVDS termination. A sample circuit illustrating a valid termination technique for transmitting LVDS signals appears in [Figure 54](#). A sample circuit illustrating a valid termination for receiving LVDS signals appears in [Figure 55](#). [Table 38](#) lists DC voltage specifications. Further information on the specific termination resistor packs shown can be found on [Table 40](#).



[Figure 54: Transmitting LVDS Signal Circuit](#)



[Figure 55: Receiving LVDS Signal Circuit](#)

[Table 38: LVDS Voltage Specifications](#)

Parameter	Min	Typ	Max
V _{CCO}	2.375	2.5	2.625
V _{ICM} ⁽²⁾	0.2	1.25	2.2
V _{OCM} ⁽¹⁾	1.125	1.25	1.375
V _{IDIFF} ⁽¹⁾	0.1	0.35	-
V _{ODIFF} ⁽¹⁾	0.25	0.35	0.45
V _{OH} ⁽¹⁾	1.25	-	-
V _{OL} ⁽¹⁾	-	-	1.25

Notes:

1. Measured with a 100 Ω resistor across Q and \bar{Q} .
2. Measured with a differential input voltage = $+/- 350$ mV.

LVPECL

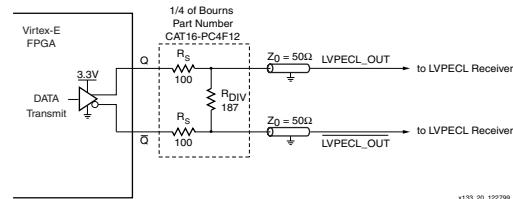
Depending on whether the device is transmitting or receiving an LVPECL signal, two different circuits are used for LVPECL termination. A sample circuit illustrating a valid termination technique for transmitting LVPECL signals appears in [Figure 56](#). A sample circuit illustrating a valid termination for receiving LVPECL signals appears in [Figure 57](#). [Table 39](#) lists DC voltage specifications. Further information on the specific termination resistor packs shown can be found on [Table 40](#).

[Table 39: LVPECL Voltage Specifications](#)

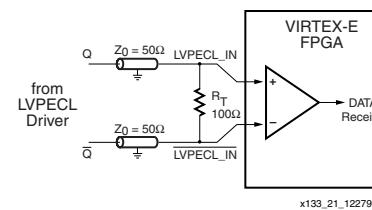
Parameter	Min	Typ	Max
V _{CCO}	3.0	3.3	3.6
V _{REF}	-	-	-
V _{TT}	-	-	-
V _{IH}	1.49	-	2.72
V _{IL}	0.86	-	2.125
V _{OH}	1.8	-	-
V _{OL}	-	-	1.57

Notes:

1. For more detailed information, see [DS022-3: Virtex-E 1.8V FPGA DC and Switching Characteristics](#), Module 3, LVPECL DC Specifications section.



[Figure 56: Transmitting LVPECL Signal Circuit](#)



[Figure 57: Receiving LVPECL Signal Circuit](#)

Table 2: IOB Input Switching Characteristics (Continued)

			Speed Grade ⁽¹⁾				Units			
Description ⁽²⁾	Symbol	Device	Min	-8	-7	-6				
Sequential Delays										
Clock CLK										
Minimum Pulse Width, High	T_{CH}	All	0.56	1.2	1.3	1.4	ns, min			
Minimum Pulse Width, Low	T_{CL}		0.56	1.2	1.3	1.4	ns, min			
Clock CLK to output IQ	T_{IOCKIQ}		0.18	0.4	0.7	0.7	ns, max			
Setup and Hold Times with respect to Clock at IOB Input Register										
Pad, no delay	T_{IOPICK}/T_{IOICKP}	All	0.69 / 0	1.3 / 0	1.4 / 0	1.5 / 0	ns, min			
Pad, with delay	$T_{IOPICKD}/T_{IOICKPD}$	XCV50E XCV100E XCV200E XCV300E XCV400E XCV600E XCV1000E XCV1600E XCV2000E XCV2600E XCV3200E	1.25 / 0 1.25 / 0 1.33 / 0 1.33 / 0 1.37 / 0 1.49 / 0 1.49 / 0 1.53 / 0 1.53 / 0 1.53 / 0 1.53 / 0	2.8 / 0 2.8 / 0 3.0 / 0 3.0 / 0 3.1 / 0 3.4 / 0 3.4 / 0 3.5 / 0 3.5 / 0 3.5 / 0 3.5 / 0	2.9 / 0 2.9 / 0 3.1 / 0 3.1 / 0 3.2 / 0 3.5 / 0 3.5 / 0 3.6 / 0 3.6 / 0 3.6 / 0 3.6 / 0	2.9 / 0 2.9 / 0 3.1 / 0 3.1 / 0 3.2 / 0 3.5 / 0 3.5 / 0 3.6 / 0 3.6 / 0 3.6 / 0 3.6 / 0	ns, min ns, min			
ICE input	$T_{IOICECK}/T_{IOCKICE}$	All	0.28 / 0.0	0.55 / 0.01	0.7 / 0.01	0.7 / 0.01	ns, min			
SR input (IFF, synchronous)	$T_{IOSRCKI}$	All	0.38	0.8	0.9	1.0	ns, min			
Set/Reset Delays										
SR input to IQ (asynchronous)	T_{IOSRIQ}	All	0.54	1.1	1.2	1.4	ns, max			
GSR to output IQ	T_{GSRQ}	All	3.88	7.6	8.5	9.7	ns, max			

Notes:

1. A Zero "0" Hold Time listing indicates no hold time or a negative hold time. Negative values can not be guaranteed "best-case", but if a "0" is listed, there is no positive hold time.
2. Input timing i for LVTTL is measured at 1.4 V. For other I/O standards, see Table 4.

CLB Arithmetic Switching Characteristics

Setup times not listed explicitly can be approximated by decreasing the combinatorial delays by the setup time adjustment listed. Precise values are provided by the timing analyzer.

Description	Symbol	Speed Grade ⁽¹⁾			Units
		Min	-8	-7	
Combinatorial Delays					
F operand inputs to X via XOR	T_{OPX}	0.32	0.68	0.8	0.8
F operand input to XB output	T_{OPXB}	0.35	0.65	0.8	0.9
F operand input to Y via XOR	T_{OPY}	0.59	1.07	1.4	1.5
F operand input to YB output	T_{OPYB}	0.48	0.89	1.1	1.3
F operand input to COUT output	T_{OPCYF}	0.37	0.71	0.9	1.0
G operand inputs to Y via XOR	T_{OPGY}	0.34	0.72	0.8	0.9
G operand input to YB output	T_{OPGYB}	0.47	0.78	1.2	1.3
G operand input to COUT output	T_{OPCYG}	0.36	0.60	0.9	1.0
BX initialization input to COUT	T_{BXCY}	0.19	0.36	0.51	0.57
CIN input to X output via XOR	T_{CINX}	0.27	0.50	0.6	0.7
CIN input to XB	T_{CINXB}	0.02	0.04	0.07	0.08
CIN input to Y via XOR	T_{CINY}	0.26	0.45	0.7	0.7
CIN input to YB	T_{CINYB}	0.16	0.28	0.38	0.43
CIN input to COUT output	T_{BYP}	0.05	0.10	0.14	0.15
Multiplier Operation					
F1/2 operand inputs to XB output via AND	T_{FANDXB}	0.10	0.30	0.35	0.39
F1/2 operand inputs to YB output via AND	T_{FANDYB}	0.28	0.56	0.7	0.8
F1/2 operand inputs to COUT output via AND	T_{FANDCY}	0.17	0.38	0.46	0.51
G1/2 operand inputs to YB output via AND	T_{GANDYB}	0.20	0.46	0.55	0.7
G1/2 operand inputs to COUT output via AND	T_{GANDCY}	0.09	0.28	0.30	0.34
Setup and Hold Times before/after Clock CLK					
CIN input to FFX	T_{CCKX}/T_{CKCX}	0.47 / 0	1.0 / 0	1.2 / 0	1.3 / 0
CIN input to FFY	T_{CCKY}/T_{CKCY}	0.49 / 0	0.92 / 0	1.2 / 0	1.3 / 0

Notes:

1. A Zero "0" Hold Time listing indicates no hold time or a negative hold time. Negative values can not be guaranteed "best-case", but if a "0" is listed, there is no positive hold time.

Revision History

The following table shows the revision history for this document.

Date	Version	Revision
12/7/99	1.0	Initial Xilinx release.
1/10/00	1.1	Re-released with spd.txt v. 1.18, FG860/900/1156 package information, and additional DLL, Select RAM and SelectI/O information.
1/28/00	1.2	Added Delay Measurement Methodology table, updated SelectI/O section, Figures 30, 54, & 55, text explaining Table 5, T_{BYP} values, buffered Hex Line info, p. 8, I/O Timing Measurement notes, notes for Tables 15, 16, and corrected F1156 pinout table footnote references.
2/29/00	1.3	Updated pinout tables, V_{CC} page 20, and corrected Figure 20.
5/23/00	1.4	Correction to table on p. 22.
7/10/00	1.5	<ul style="list-style-type: none"> • Numerous minor edits. • Data sheet upgraded to Preliminary. • Preview -8 numbers added to Virtex-E Electrical Characteristics tables.
8/1/00	1.6	<ul style="list-style-type: none"> • Reformatted entire document to follow new style guidelines. • Changed speed grade values in tables on pages 35-37.
9/20/00	1.7	<ul style="list-style-type: none"> • Min values added to Virtex-E Electrical Characteristics tables. • XCV2600E and XCV3200E numbers added to Virtex-E Electrical Characteristics tables (Module 3). • Corrected user I/O count for XCV100E device in Table 1 (Module 1). • Changed several pins to "No Connect in the XCV100E" and removed duplicate V_{CCINT} pins in Table ~ (Module 4). • Changed pin J10 to "No connect in XCV600E" in Table 74 (Module 4). • Changed pin J30 to "VREF option only in the XCV600E" in Table 74 (Module 4). • Corrected pair 18 in Table 75 (Module 4) to be "AO in the XCV100E, XCV1600E".
11/20/00	1.8	<ul style="list-style-type: none"> • Upgraded speed grade -8 numbers in Virtex-E Electrical Characteristics tables to Preliminary. • Updated minimums in Table 13 and added notes to Table 14. • Added note 2 to Absolute Maximum Ratings. • Changed speed grade -8 numbers for $T_{SHCKO32}$, T_{REG}, T_{BCCS}, and T_{ICKOF}. • Changed all minimum hold times to -0.4 under Global Clock Set-Up and Hold for LVTTL Standard, with DLL. • Revised maximum T_{DLLPW} in -6 speed grade for DLL Timing Parameters. • Changed GCLK0 to BA22 for FG860 package in Table 46.
2/12/01	1.9	<ul style="list-style-type: none"> • Revised footnote for Table 14. • Added numbers to Virtex-E Electrical Characteristics tables for XCV1000E and XCV2000E devices. • Updated Table 27 and Table 78 to include values for XCV400E and XCV600E devices. • Revised Table 62 to include pinout information for the XCV400E and XCV600E devices in the BG560 package. • Updated footnotes 1 and 2 for Table 76 to include XCV2600E and XCV3200E devices.
4/02/01	2.0	<ul style="list-style-type: none"> • Updated numerous values in Virtex-E Switching Characteristics tables. • Converted data sheet to modularized format. See the Virtex-E Data Sheet section.
4/19/01	2.1	<ul style="list-style-type: none"> • Updated values in Virtex-E Switching Characteristics tables.

Date	Version	Revision
07/23/01	2.2	<ul style="list-style-type: none"> Under Absolute Maximum Ratings, changed (T_{SOL}) to 220 °C. Changes made to SSTL symbol names in IOB Input Switching Characteristics Standard Adjustments table.
07/26/01	2.3	<ul style="list-style-type: none"> Removed T_{SOL} parameter and added footnote to Absolute Maximum Ratings table.
9/18/01	2.4	<ul style="list-style-type: none"> Reworded power supplies footnote to Absolute Maximum Ratings table.
10/25/01	2.5	<ul style="list-style-type: none"> Updated the speed grade designations used in data sheets, and added Table 1, which shows the current speed grade designation for each device. Added XCV2600E and XCV3200E values to DC Characteristics Over Recommended Operating Conditions and Power-On Power Supply Requirements tables.
11/09/01	2.6	<ul style="list-style-type: none"> Updated the Power-On Power Supply Requirements table.
02/01/02	2.7	<ul style="list-style-type: none"> Updated footnotes to the DC Input and Output Levels and DLL Clock Tolerance, Jitter, and Phase Information tables.
07/17/02	2.8	<ul style="list-style-type: none"> Data sheet designation upgraded from Preliminary to Production. Removed mention of MIL-M-38510/605 specification. Added link to XAPP158 from the Power-On Power Supply Requirements section.
09/10/02	2.9	<ul style="list-style-type: none"> Revised V_{IN} in Absolute Maximum Ratings table. Added Clock CLK switching characteristics to Table 2, “IOB Input Switching Characteristics,” on page 6 and IOB Output Switching Characteristics, Figure 1.
12/22/02	2.9.1	<ul style="list-style-type: none"> Added footnote regarding V_{IN} PCI compliance to Absolute Maximum Ratings table. The fastest ramp rate is 0V to nominal voltage in 2 ms
03/14/03	2.9.2	<ul style="list-style-type: none"> Under Power-On Power Supply Requirements, the fastest ramp rate is no longer a "suggested" rate.

Virtex-E Data Sheet

The Virtex-E Data Sheet contains the following modules:

- DS022-1, Virtex-E 1.8V FPGAs:
[Introduction and Ordering Information \(Module 1\)](#)
- DS022-2, Virtex-E 1.8V FPGAs:
[Functional Description \(Module 2\)](#)
- DS022-3, Virtex-E 1.8V FPGAs:
[DC and Switching Characteristics \(Module 3\)](#)
- DS022-4, Virtex-E 1.8V FPGAs:
[Pinout Tables \(Module 4\)](#)

Table 12: BG432 — XCV300E, XCV400E, XCV600E

Bank	Pin Description	Pin #
0	IO_L12N_YY	A20
0	IO_L12P_YY	D19
0	IO_VREF_L13N_YY	B19
0	IO_L13P_YY	A19
0	IO_L14N_Y	B18
0	IO_L14P_Y	D18
0	IO_VREF_L15N_Y	C18 ²
0	IO_L15P_Y	B17
0	IO_LVDS_DLL_L16N	C17
<hr/>		
1	GCK2	A16
1	IO	A12
1	IO	B9
1	IO	B11
1	IO	C16
1	IO	D9
1	IO_LVDS_DLL_L16P	B16
1	IO_L17N_Y	A15
1	IO_VREF_L17P_Y	B15 ²
1	IO_L18N_Y	C15
1	IO_L18P_Y	D15
1	IO_L19N_YY	B14
1	IO_VREF_L19P_YY	A13
1	IO_L20N_YY	B13
1	IO_L20P_YY	D14
1	IO_L21N_YY	C13
1	IO_L21P_YY	B12
1	IO_L22N_YY	D13
1	IO_L22P_YY	C12
1	IO_L23N_YY	D12
1	IO_L23P_YY	C11
1	IO_L24N_YY	B10
1	IO_VREF_L24P_YY	C10
1	IO_L25N_Y	C9
1	IO_VREF_L25P_Y	D10 ¹
1	IO_L26N_Y	A8

Table 12: BG432 — XCV300E, XCV400E, XCV600E

Bank	Pin Description	Pin #
1	IO_L26P_Y	B8
1	IO_L27N_YY	C8
1	IO_VREF_L27P_YY	B7
1	IO_L28N_YY	D8
1	IO_L28P_YY	A6
1	IO_L29N_Y	B6
1	IO_L29P_Y	D7
1	IO_L30N_YY	A5
1	IO_VREF_L30P_YY	C6
1	IO_L31N_YY	B5
1	IO_L31P_YY	D6
1	IO_L32N_Y	A4
1	IO_L32P_Y	C5
1	IO_WRITE_L33N_YY	B4
1	IO_CS_L33P_YY	D5
<hr/>		
2	IO	H4
2	IO	J3
2	IO	L3
2	IO	M1
2	IO	R2
2	IO_DOUT_BUSY_L34P_YY	D3
2	IO_DIN_D0_L34N_YY	C2
2	IO_L35P	D2
2	IO_L35N	E4
2	IO_L36P_Y	D1
2	IO_L36N_Y	E3
2	IO_VREF_L37P_Y	E2
2	IO_L37N_Y	F4
2	IO_L38P	E1
2	IO_L38N	F3
2	IO_L39P_Y	F2
2	IO_L39N_Y	G4
2	IO_VREF_L40P_YY	G3
2	IO_L40N_YY	G2
2	IO_L41P_Y	H3

Table 14: BG560 — XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E

Bank	Pin Description	Pin#	See Note
4	IO_L104N_YY	AJ12	
4	IO_L105P_Y	AN11	
4	IO_L105N_Y	AK12	
4	IO_L106P_YY	AL12	
4	IO_L106N_YY	AM12	
4	IO_VREF_L107P_YY	AK13	3
4	IO_L107N_YY	AL13	
4	IO_L108P_Y	AM13	
4	IO_L108N_Y	AN13	
4	IO_L109P_YY	AJ14	
4	IO_L109N_YY	AK14	
4	IO_VREF_L110P_YY	AM14	
4	IO_L110N_YY	AN15	
4	IO_L111P_Y	AJ15	
4	IO_L111N_Y	AK15	
4	IO_L112P_Y	AL15	
4	IO_L112N_Y	AM16	
4	IO_VREF_L113P_Y	AL16	
4	IO_L113N_Y	AJ16	
4	IO_L114P_Y	AK16	
4	IO_VREF_L114N_Y	AN17	2
4	IO_LVDS_DLL_L115P	AM17	
<hr/>			
5	GCK1	AJ17	
5	IO	AL25	
5	IO	AL28	
5	IO	AL30	
5	IO	AN28	
5	IO_LVDS_DLL_L115N	AM18	
5	IO_VREF	AL18	2
5	IO_L116P_Y	AK18	
5	IO_VREF_L116N_Y	AJ18	
5	IO_L117P_Y	AN19	
5	IO_L117N_Y	AL19	
5	IO_L118P_Y	AK19	

Table 14: BG560 — XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E

Bank	Pin Description	Pin#	See Note
5	IO_L118N_Y	AM20	
5	IO_L119P_YY	AJ19	
5	IO_VREF_L119N_YY	AL20	
5	IO_L120P_YY	AN21	
5	IO_L120N_YY	AL21	
5	IO_L121P_Y	AJ20	
5	IO_L121N_Y	AM22	
5	IO_L122P_YY	AK21	
5	IO_VREF_L122N_YY	AN23	3
5	IO_L123P_YY	AJ21	
5	IO_L123N_YY	AM23	
5	IO_L124P_Y	AK22	
5	IO_L124N_Y	AM24	
5	IO_L125P_YY	AL23	
5	IO_L125N_YY	AJ22	
5	IO_L126P_YY	AK23	
5	IO_VREF_L126N_YY	AL24	
5	IO_L127P_Y	AN26	
5	IO_L127N_Y	AJ23	
5	IO_L128P_Y	AK24	
5	IO_VREF_L128N_Y	AM26	4
5	IO_L129P_Y	AM27	
5	IO_L129N_Y	AJ24	
5	IO_L130P_Y	AL26	
5	IO_VREF_L130N_Y	AK25	1
5	IO_L131P_YY	AN29	
5	IO_VREF_L131N_YY	AJ25	
5	IO_L132P_YY	AK26	
5	IO_L132N_YY	AM29	
5	IO_L133P_Y	AM30	
5	IO_L133N_Y	AJ26	
5	IO_L134P_YY	AK27	
5	IO_VREF_L134N_YY	AL29	
5	IO_L135P_YY	AN31	
5	IO_L135N_YY	AJ27	

Table 14: BG560 — XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E

Bank	Pin Description	Pin#	See Note
NA	GND	A29	
NA	GND	A32	
NA	GND	A33	
NA	GND	B1	
NA	GND	B6	
NA	GND	B9	
NA	GND	B15	
NA	GND	B23	
NA	GND	B27	
NA	GND	B31	
NA	GND	C2	
NA	GND	E1	
NA	GND	F32	
NA	GND	G2	
NA	GND	G33	
NA	GND	J32	
NA	GND	K1	
NA	GND	L2	
NA	GND	M33	
NA	GND	P1	
NA	GND	P33	
NA	GND	R32	
NA	GND	T1	
NA	GND	V33	
NA	GND	W2	
NA	GND	Y1	
NA	GND	Y33	
NA	GND	AB1	
NA	GND	AC32	
NA	GND	AD33	
NA	GND	AE2	
NA	GND	AG1	
NA	GND	AG32	
NA	GND	AH2	
NA	GND	AJ33	

Table 14: BG560 — XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E

Bank	Pin Description	Pin#	See Note
NA	GND	AL32	
NA	GND	AM3	
NA	GND	AM7	
NA	GND	AM11	
NA	GND	AM19	
NA	GND	AM25	
NA	GND	AM28	
NA	GND	AM33	
NA	GND	AN1	
NA	GND	AN2	
NA	GND	AN5	
NA	GND	AN10	
NA	GND	AN14	
NA	GND	AN16	
NA	GND	AN20	
NA	GND	AN22	
NA	GND	AN27	
NA	GND	AN33	

Notes:

1. V_{REF} or I/O option only in the XCV2000E; otherwise, I/O option only.
2. V_{REF} or I/O option only in the XCV1600E & 2000E; otherwise, I/O option only.
3. V_{REF} or I/O option only in the XCV1000E, 1600E, & 2000E; otherwise, I/O option only.
4. V_{REF} or I/O option only in the XCV600E, 1000E, 1600E, & 2000E; otherwise, I/O option only.

Table 15: BG560 Differential Pin Pair Summary
XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E

Pair	Bank	P Pin	N Pin	AO	Other Functions
109	4	AJ14	AK14	✓	-
110	4	AM14	AN15	✓	VREF
111	4	AJ15	AK15	1	-
112	4	AL15	AM16	7	-
113	4	AL16	AJ16	7	VREF
114	4	AK16	AN17	2	VREF
115	5	AM17	AM18	NA	IO_LVDS_DLL
116	5	AK18	AJ18	7	VREF
117	5	AN19	AL19	7	-
118	5	AK19	AM20	9	-
119	5	AJ19	AL20	✓	VREF
120	5	AN21	AL21	✓	-
121	5	AJ20	AM22	3	-
122	5	AK21	AN23	✓	VREF
123	5	AJ21	AM23	✓	-
124	5	AK22	AM24	8	-
125	5	AL23	AJ22	✓	-
126	5	AK23	AL24	✓	VREF
127	5	AN26	AJ23	13	-
128	5	AK24	AM26	7	VREF
129	5	AM27	AJ24	7	-
130	5	AL26	AK25	5	VREF
131	5	AN29	AJ25	✓	VREF
132	5	AK26	AM29	✓	-
133	5	AM30	AJ26	11	-
134	5	AK27	AL29	✓	VREF
135	5	AN31	AJ27	✓	-
136	5	AM31	AK28	12	VREF
137	6	AJ30	AH29	✓	-
138	6	AH30	AK31	17	VREF
139	6	AJ31	AG29	14	-

Table 15: BG560 Differential Pin Pair Summary
XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E

Pair	Bank	P Pin	N Pin	AO	Other Functions
140	6	AG30	AK32	15	VREF
141	6	AF29	AH31	16	-
142	6	AF30	AH32	15	-
143	6	AH33	AE29	✓	VREF
144	6	AE30	AG33	17	VREF
145	6	AF32	AD29	14	-
146	6	AD30	AE31	18	VREF
147	6	AC29	AE32	19	-
148	6	AC30	AD31	✓	VREF
149	6	AC31	AB29	✓	-
150	6	AB30	AC33	17	-
151	6	AA29	AB31	14	-
152	6	AA31	AA30	15	VREF
153	6	Y29	AA32	16	-
154	6	Y30	AA33	15	-
155	6	W29	Y32	✓	VREF
156	6	W31	W30	17	-
157	6	V30	W33	14	-
158	6	V31	V29	18	VREF
159	6	U33	V32	19	VREF
160	7	U32	U31	✓	-
161	7	T30	T32	19	VREF
162	7	T31	T29	18	VREF
163	7	R31	R33	14	-
164	7	R29	R30	17	-
165	7	P31	P32	✓	VREF
166	7	P29	P30	15	-
167	7	N31	M32	16	-
168	7	L33	N30	15	VREF
169	7	L32	M31	14	-
170	7	L31	M30	17	-

**Table 17: FG256 Differential Pin Pair Summary
XCV50E, XCV100E, XCV200E, XCV300E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
19	2	C15	D14	✓	DIN, D0
20	2	B16	E13	6	VREF
21	2	C16	E14	✓	-
22	2	F13	E15	1	VREF
23	2	F12	D16	5	-
24	2	F14	E16	3	D1
25	2	F15	G13	✓	D2
26	2	F16	G12	6	-
27	2	G15	G14	✓	-
28	2	H13	G16	3	D3
29	2	J13	H15	4	-
30	2	H14	H16	✓	-
31	3	K15	J14	4	-
32	3	J16	K16	3	VREF
33	3	K12	L15	✓	-
34	3	K13	L16	6	-
35	3	K14	M16	✓	D5
36	3	N16	L13	3	VREF
37	3	P16	L12	5	-
38	3	M15	L14	1	VREF
39	3	M14	R16	✓	-
40	3	M13	T15	6	VREF
41	3	N14	N15	✓	INIT
42	4	T14	P13	✓	-
43	4	P12	R13	7	VREF
44	4	N12	T13	✓	-
45	4	T12	P11	✓	VREF
46	4	R12	N11	2	-
47	4	T11	M11	✓	VREF
48	4	R11	T10	✓	-
49	4	R10	M10	1	-
50	4	P9	T9	1	VREF
51	4	N10	R9	1	-
52	5	N9	T8	NA	IO_LVDS_DLL
53	5	R7	P8	1	VREF
54	5	P7	T6	1	-

**Table 17: FG256 Differential Pin Pair Summary
XCV50E, XCV100E, XCV200E, XCV300E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
55	5	M7	R6	✓	-
56	5	P6	R5	✓	VREF
57	5	N6	T5	2	-
58	5	M6	T4	✓	VREF
59	5	T3	P5	✓	-
60	5	T2	N5	7	VREF
61	6	R1	M3	✓	-
62	6	N2	M4	6	VREF
63	6	P1	L5	✓	-
64	6	L3	N1	1	VREF
65	6	L4	M2	5	-
66	6	K4	M1	3	VREF
67	6	L1	L2	✓	-
68	6	K1	K3	6	-
69	6	K5	K2	✓	-
70	6	J1	J3	3	VREF
71	6	H1	J4	4	-
72	7	H4	G1	✓	-
73	7	H2	G5	4	-
74	7	H3	G4	3	VREF
75	7	F5	G2	✓	-
76	7	F1	F4	6	-
77	7	F2	G3	✓	-
78	7	D1	E1	3	VREF
79	7	E2	E4	5	-
80	7	C1	F3	1	VREF
81	7	E3	D2	✓	-
82	7	A2	B1	6	VREF

Notes:

1. AO in the XCV50E, 200E, 300E.
2. AO in the XCV50E, 200E.
3. AO in the XCV50E, 300E.
4. AO in the XCV100E, 200E.
5. AO in the XCV200E.
6. AO in the XCV100E.
7. AO in the XCV50E.

Table 20: FG676 — XCV400E, XCV600E

Bank	Pin Description	Pin #
3	IO	Y26
3	IO	AB25
3	IO	AC25 ¹
3	IO	AC26
3	IO_L69P_YY	P21
3	IO_L69N_YY	P23
3	IO_L70P_Y	P22
3	IO_VREF_L70N_Y	R25
3	IO_L71P_Y	P19
3	IO_L71N_Y	P20
3	IO_L72P_YY	R21
3	IO_L72N_YY	R22
3	IO_D4_L73P_YY	R24
3	IO_VREF_L73N_YY	R23
3	IO_L74P_Y	T24
3	IO_L74N_Y	R20
3	IO_L75P_Y	T22
3	IO_L75N_Y	U24
3	IO_L76P_Y	T23
3	IO_L76N_Y	U25
3	IO_L77P_Y	T21
3	IO_L77N_Y	U20
3	IO_L78P_YY	U22
3	IO_L78N_YY	V26
3	IO_L79P_YY	T20
3	IO_D5_L79N_YY	U23
3	IO_D6_L80P_YY	V24
3	IO_VREF_L80N_YY	U21
3	IO_L81P_YY	V23
3	IO_L81N_YY	W24
3	IO_L82P_Y	V22
3	IO_VREF_L82N_Y	W26 ²
3	IO_L83P_Y	Y25
3	IO_L83N_Y	V21
3	IO_L84P_YY	V20
3	IO_L84N_YY	AA26
3	IO_L85P_YY	Y24

Table 20: FG676 — XCV400E, XCV600E

Bank	Pin Description	Pin #
3	IO_VREF_L85N_YY	W23
3	IO_L86P_Y	AA24
3	IO_L86N_Y	Y23
3	IO_L87P_Y	AB26
3	IO_L87N_Y	W21
3	IO_L88P_Y	Y22
3	IO_VREF_L88N_Y	W22
3	IO_L89P_Y	AA23
3	IO_L89N_Y	AB24
3	IO_L90P_YY	W20
3	IO_L90N_YY	AC24
3	IO_D7_L91P_YY	AB23
3	IO_INIT_L91N_YY	Y21
4	GCK0	AA14
4	IO	AC18
4	IO	AE15 ¹
4	IO	AE20
4	IO	AE23
4	IO	AF14 ¹
4	IO	AF16 ¹
4	IO	AF18 ¹
4	IO	AF21
4	IO	AF23 ¹
4	IO_L92P_YY	AC22
4	IO_L92N_YY	AD26
4	IO_L93P_Y	AD23
4	IO_L93N_Y	AA20
4	IO_L94P_YY	Y19
4	IO_L94N_YY	AC21
4	IO_VREF_L95P_YY	AD22
4	IO_L95N_YY	AB20
4	IO_L96P	AE22
4	IO_L96N	Y18
4	IO_L97P	AF22
4	IO_L97N	AA19
4	IO_VREF_L98P_YY	AD21

Table 24: FG860 — XCV1000E, XCV1600E, XCV2000E

Bank	Pin Description	Pin #
NA	GND	C42
NA	GND	C41
NA	GND	C40
NA	GND	C3
NA	GND	C2
NA	GND	C1
NA	GND	BB41
NA	GND	BB40
NA	GND	BB4
NA	GND	BB39
NA	GND	BB3
NA	GND	BB2
NA	GND	BA42
NA	GND	BA41
NA	GND	BA40
NA	GND	BA3
NA	GND	BA2
NA	GND	BA1
NA	GND	B42
NA	GND	B41
NA	GND	B40
NA	GND	B3
NA	GND	B2
NA	GND	B1
NA	GND	AY42
NA	GND	AY41
NA	GND	AY40
NA	GND	AY3
NA	GND	AY2
NA	GND	AY1
NA	GND	AW42
NA	GND	AW4
NA	GND	AW39
NA	GND	AW1
NA	GND	AV5
NA	GND	AV38
NA	GND	AV30

Table 24: FG860 — XCV1000E, XCV1600E, XCV2000E

Bank	Pin Description	Pin #
NA	GND	AV22
NA	GND	AV21
NA	GND	AV13
NA	GND	AU6
NA	GND	AU37
NA	GND	AU30
NA	GND	AU22
NA	GND	AU21
NA	GND	AU13
NA	GND	AK6
NA	GND	AK5
NA	GND	AK38
NA	GND	AK37
NA	GND	AB6
NA	GND	AB5
NA	GND	AB38
NA	GND	AB37
NA	GND	AA6
NA	GND	AA5
NA	GND	AA38
NA	GND	AA37
NA	GND	A41
NA	GND	A40
NA	GND	A4
NA	GND	A39
NA	GND	A3
NA	GND	A2

Notes:

1. V_{REF} or I/O option only in the XCV1600E, 2000E; otherwise, I/O option only.
2. V_{REF} or I/O option only in the XCV2000E; otherwise, I/O option only.

FG860 Differential Pin Pairs

Virtex-E devices have differential pin pairs that can also provide other functions when not used as a differential pair. A √ in the AO column indicates that the pin pair can be used as an asynchronous output for all devices provided in this package. Pairs with a note number in the AO column are device dependent. They can have asynchronous outputs if the pin pair are in the same CLB row and column in the device. Numbers in this column refer to footnotes that indicate which devices have pin pairs than can be asynchronous outputs. The Other Functions column indicates alternative function(s) not available when the pair is used as a differential pair or differential clock.

**Table 25: FG860 Differential Pin Pair Summary
XCV1000E, XCV1600E, XCV2000E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
Global Differential Clock					
3	0	C22	A22	NA	IO_DLL_L34N
2	1	B22	D22	NA	IO_DLL_L34P
1	5	AY22	AW21	NA	IO_DLL_L176N
0	4	BA22	AW20	NA	IO_DLL_L176P
IO LVDS					
Total Pairs: 281, Asynchronous Output Pairs: 111					
0	0	D38	A38	2	-
1	0	E37	B37	1	-
2	0	C39	A37	1	VREF
3	0	C38	B36	1	-
4	0	B35	A36	√	-
5	0	D37	A35	√	VREF
6	0	A34	C37	5	-
7	0	B33	E36	5	-
8	0	C32	A33	√	-
9	0	B32	C36	√	VREF
10	0	D35	A32	1	-
11	0	C35	C31	1	VREF
12	0	A31	E34	√	-
13	0	C30	D34	√	VREF
14	0	E33	B30	2	-
15	0	D33	A30	2	-
16	0	B29	C33	√	VREF
17	0	A29	E32	√	-

**Table 25: FG860 Differential Pin Pair Summary
XCV1000E, XCV1600E, XCV2000E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
18	0	C28	D32	2	-
19	0	B28	E31	1	-
20	0	A28	D31	1	-
21	0	C27	D30	5	-
22	0	B27	E29	√	-
23	0	A27	D29	√	VREF
24	0	D28	C26	5	-
25	0	F27	B26	5	-
26	0	C25	E27	√	-
27	0	B25	D27	√	VREF
28	0	D26	A25	1	-
29	0	E25	A24	1	-
30	0	B24	D25	√	-
31	0	A23	E24	√	VREF
32	0	E23	C23	2	-
33	0	D23	B23	2	VREF
34	1	D22	A22	NA	IO_LVDS_DLL
35	1	B21	D21	2	VREF
36	1	A21	D20	2	-
37	1	D19	C20	√	VREF
38	1	E19	B20	√	-
39	1	A19	D18	1	-
40	1	C19	E18	1	-
41	1	E17	B19	√	VREF
42	1	D16	A18	√	-
43	1	B18	E16	5	-
44	1	A17	F16	5	-
45	1	E15	C17	√	VREF
46	1	D14	B17	√	-
47	1	E14	A16	5	-
48	1	D13	C16	1	-
49	1	D12	B16	1	-
50	1	E12	A15	2	-
51	1	C11	C15	√	-

Table 26: FG900 — XCV600E, XCV1000E, XCV1600E

Bank	Pin Description	Pin #
1	IO	J20 ⁵
1	IO	L18 ⁴
1	IO_LVDS_DLL_L34P	E16
1	IO_L35N_YY	B16
1	IO_VREF_L35P_YY	F16 ²
1	IO_L36N_YY	A16
1	IO_L36P_YY	H16
1	IO_L37N_YY	C16
1	IO_VREF_L37P_YY	K15
1	IO_L38N_YY	K16
1	IO_L38P_YY	G16
1	IO_L39N_Y	A17
1	IO_L39P_Y	E17
1	IO_L40N_Y	F17
1	IO_L40P_Y	C17
1	IO_L41N_YY	E18
1	IO_VREF_L41P_YY	A18
1	IO_L42N_YY	D18
1	IO_L42P_YY	A19
1	IO_L43N_Y	B19
1	IO_L43P_Y	G18
1	IO_L44N_Y	D19
1	IO_L44P_Y	H18
1	IO_L45N_YY	F18
1	IO_VREF_L45P_YY	F19 ¹
1	IO_L46N_YY	B20
1	IO_L46P_YY	K17
1	IO_L47N_Y	D20 ⁴
1	IO_L47P_Y	A20 ⁴
1	IO_L48N_Y	G19
1	IO_L48P_Y	C20
1	IO_L49N_Y	K18
1	IO_L49P_Y	E20
1	IO_L50N_YY	B21 ⁴
1	IO_L50P_YY	D21 ⁴
1	IO_L51N_YY	F20
1	IO_L51P_YY	A21

Table 26: FG900 — XCV600E, XCV1000E, XCV1600E

Bank	Pin Description	Pin #
1	IO_L52N_YY	C21
1	IO_VREF_L52P_YY	A22
1	IO_L53N_YY	H19
1	IO_L53P_YY	B22
1	IO_L54N_YY	E21
1	IO_L54P_YY	D22
1	IO_L55N_YY	F21
1	IO_VREF_L55P_YY	C22
1	IO_L56N_YY	H20
1	IO_L56P_YY	E22
1	IO_L57N_Y	G21
1	IO_L57P_Y	A23
1	IO_L58N_Y	A24
1	IO_L58P_Y	K19
1	IO_L59N_YY	C24
1	IO_VREF_L59P_YY	B24
1	IO_L60N_YY	H21
1	IO_L60P_YY	G22
1	IO_L61N_Y	E23
1	IO_L61P_Y	C25
1	IO_L62N_Y	D24
1	IO_L62P_Y	A26
1	IO_L63N_YY	B26
1	IO_VREF_L63P_YY	K20
1	IO_L64N_YY	D25
1	IO_L64P_YY	J21
1	IO_L65N_Y	C26 ⁴
1	IO_L65P_Y	F23 ⁴
1	IO_L66N_Y	B27
1	IO_VREF_L66P_Y	G23 ¹
1	IO_L67N_Y	A27
1	IO_L67P_Y	F24
1	IO_L68N_YY	B28 ³
1	IO_L68P_YY	A28 ⁴
1	IO_WRITE_L69N_YY	K21
1	IO_CS_L69P_YY	C27

Table 28: FG1156 — XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E

Bank	Pin Description	Pin #
0	IO_L40P_Y	A17
0	IO_VREF_L41N_Y	G17 ¹
0	IO_L41P_Y	B17
0	IO_LVDS_DLL_L42N	C17
1	GCK2	D17
1	IO	A18
1	IO	B18 ³
1	IO	B24
1	IO	B25
1	IO	E22 ³
1	IO	E23 ³
1	IO	D18 ³
1	IO	D19
1	IO	D25 ³
1	IO	D26 ³
1	IO	D28 ³
1	IO	D29 ³
1	IO	G23 ³
1	IO	J23 ³
1	IO_LVDS_DLL_L42P	J18
1	IO_L43N_Y	G18
1	IO_VREF_L43P_Y	C18 ¹
1	IO_L44N_Y	H18
1	IO_L44P_Y	F18
1	IO_L45N_YY	B19
1	IO_VREF_L45P_YY	A19
1	IO_L46N_YY	K19
1	IO_L46P_YY	C19
1	IO_L47N	F19 ⁵
1	IO_L47P	E19 ⁴
1	IO_L48N_Y	G19
1	IO_L48P_Y	J19
1	IO_L49N_Y	A20

Table 28: FG1156 — XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E

Bank	Pin Description	Pin #
1	IO_L49P_Y	G20
1	IO_L50N	B20 ⁵
1	IO_L50P	F20 ⁴
1	IO_L51N_YY	D20
1	IO_VREF_L51P_YY	E20
1	IO_L52N_YY	H20
1	IO_L52P_YY	A21
1	IO_L53N	E21 ⁵
1	IO_L53P	J20 ⁴
1	IO_L54N_Y	D21
1	IO_L54P_Y	K20
1	IO_L55N_Y	B21
1	IO_L55P_Y	H21
1	IO_L56N_YY	G21 ⁵
1	IO_L56P_YY	F21 ⁴
1	IO_L57N_YY	A22
1	IO_VREF_L57P_YY	B22
1	IO_L58N_YY	J21
1	IO_L58P_YY	C22
1	IO_L59N_Y	D22
1	IO_L59P_Y	G22
1	IO_L60N_Y	K21
1	IO_L60P_Y	A23
1	IO_L61N_Y	F22
1	IO_L61P_Y	B23
1	IO_L62N_Y	C23
1	IO_L62P_Y	H22
1	IO_L63N_YY	D23
1	IO_L63P_YY	K22
1	IO_L64N_YY	A24
1	IO_VREF_L64P_YY	J22
1	IO_L65N_Y	H23
1	IO_L65P_Y	D24
1	IO_L66N_Y	A25

Table 28: FG1156 — XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E

Bank	Pin Description	Pin #
NA	VCCO_7	K5
NA	VCCO_7	F1
NA	VCCO_7	T11
NA	VCCO_7	T12
NA	VCCO_7	R11
NA	VCCO_7	R12
NA	VCCO_7	P3
NA	VCCO_7	P11
NA	VCCO_7	P12
NA	VCCO_7	N11
NA	GND	K32
NA	GND	R4
NA	GND	AN1
NA	GND	AM11
NA	GND	AK5
NA	GND	AH28
NA	GND	AD32
NA	GND	AA20
NA	GND	Y20
NA	GND	W19
NA	GND	V19
NA	GND	U20
NA	GND	T20
NA	GND	R19
NA	GND	P19
NA	GND	H8
NA	GND	F12
NA	GND	C2
NA	GND	B1
NA	GND	A7
NA	GND	AP1
NA	GND	AN2
NA	GND	AM15

Table 28: FG1156 — XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E

Bank	Pin Description	Pin #
NA	GND	AK17
NA	GND	AH34
NA	GND	AC6
NA	GND	AA21
NA	GND	Y21
NA	GND	W20
NA	GND	V20
NA	GND	U21
NA	GND	T21
NA	GND	R20
NA	GND	P20
NA	GND	H16
NA	GND	F23
NA	GND	C3
NA	GND	B2
NA	GND	A28
NA	GND	AP34
NA	GND	AM3
NA	GND	AL31
NA	GND	AH7
NA	GND	AD3
NA	GND	AA19
NA	GND	Y19
NA	GND	W18
NA	GND	V18
NA	GND	U19
NA	GND	T19
NA	GND	R18
NA	GND	P18
NA	GND	J26
NA	GND	F6
NA	GND	C1
NA	GND	C34
NA	GND	A3